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AMENDMENT TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the

application. The following listing provides the amended claims with the amendments marked

with deleted material crossed out and new material underlined to show the changes made.

Claims 1-15 (Canceled).

16. (Currently Amended) An integrated circuit comprising:

a plurality of metal layers comprising a plurality of conductors to interconnect

components in said integrated circuit, said metal layers comprising:

a first metal layer group comprising at least one metal layer, said metal layer in said first

metal layer group comprising at least one pre-designed circuit block self-contained layout section

comprising conductors deposed in a preferred Manhattan direction, wherein a preferred direction

defines a direction, relative to the integrated circuit boundaries, for at least fifty percent of

conductors and said pre-designed circuit block self contained layout section comprising a routing

of conductors developed independent from routing of conductors for circuits outside said pre-

designed circuit block self-contained layout section in said integrated circuit; and

a second metal layer group comprising at least one metal layer, said metal layer in said

second metal layer group comprising a plurality of conductors deposed in a preferred diagonal

direction in a portion of said metal layer in said second metal layer group directly adjacent to said

pre-designed circuit block, wherein at least one conductor along said preferred diagonal direction

on the metal layer directly above said pre-designed circuit block traverses across the boundaries

of said pre-designed circuit block self contained layout section, and wherein conductors for said

second metal layer group are routed independent from routing of conductors for said pre-designed

circuit block self contained layout section,

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wherein said preferred Manhattan direction conductors of said pre-designed circuit block

self contained layout section within said first metal layer group do not electrically cross-couple

with conductors of said second metal layer group regardless of whether said pre-designed circuit

block self-contained layout section conductors are deposed in either a horizontal or vertical

direction; and

wherein said pre-designed circuit block self contained layout section is a section less than

the entire area of said metal layer in said first metal layer group.

17. (Currently Amended) The integrated circuit as set forth in claim 16, wherein said

pre-designed circuit block self contained layout section is independent of a layout for said second

metal layer group.

18. (Currently Amended) The integrated circuit as set forth in claim 16, further

comprising a plurality of pre-designed circuit blocks self-contained layout sections in said first

metal layer group.

19. (Currently Amended) The integrated circuit as set forth in claim 18, wherein at

least one of said pre-designed circuit blocks self contained layout sections comprise a wiring

direction perpendicular to a wiring direction of a second one of said pre-designed circuit blocks

self-contained layout-sections.

20. (Canceled).

21. (Original) The integrated circuit as set forth in claim 16, wherein said first

metal layer group comprises three metal layers.

22. (Previously Presented) The integrated circuit as set forth in claim 21,

wherein said three metal layers comprise first, second, and third metal layers, each of said three

metal layers comprising conductors deposed in preferred Manhattan directions, wherein:

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said first metal layer comprises a preferred Manhattan direction complementary of a

preferred Manhattan direction of said second metal layer; and

said second metal layer comprises a preferred Manhattan direction complementary of a

preserred Manhattan direction of said third metal layer.

23. (Original) The integrated circuit as set forth in claim 16, wherein said diagonal

direction comprises a direction 45 degrees relative to said integrated circuit boundaries.

24. (Original) The integrated circuit as set forth in claim 16, wherein said diagonal

direction comprises a direction 60 degrees relative to said integrated circuit boundaries.

25. (Currently Amended) The integrated circuit as set forth in claim 16, wherein said

pre-designed circuit block self contained layout section comprises a layout for a memory block.

26. (Canceled).

27. (Currently Amended) The integrated circuit as set forth in claim 16, wherein said

pre-designed circuit block self contained layout section comprises a section less than 10 percent

of the entire area of said metal layer in said first metal layer group.

28. (Currently Amended) A method for deposing a plurality of metal layers

comprising a plurality of conductors to interconnect components of an integrated circuit, said

method comprising the steps of:

designating a first metal layer group comprising at least one metal layer, said metal layer

in said first metal layer group comprising at least one pre-designed circuit block self-contained

layout section comprising conductors deposed in a preferred Manhattan direction, wherein a

preferred direction defines a direction, relative to the integrated circuit boundaries, for at least

fifty percent of conductors and said pre-designed circuit block self-contained layout section

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comprising a routing of conductors developed independent from routing of conductors for circuits

outside said pre-designed circuit block self contained layout section in said integrated circuit; and

designating a second metal layer group comprising at least one metal layer, said metal

layer in said second metal layer group comprising a plurality of conductors deposed in a

preferred diagonal direction in a portion of said metal layer in said second metal layer group

directly adjacent to said pre-designed circuit block, wherein at least one conductor along said

preferred diagonal direction on the metal layer directly above said pre-designed circuit block

traverses across the boundaries of said pre-designed circuit block self-contained layout-section,

and wherein conductors for said second metal layer group are routed independent from routing of

conductors for said pre-designed circuit block self-contained layout section,

wherein said preferred Manhattan direction conductors of said pre-designed circuit block

self-contained layout section within said first metal layer group do not electrically cross-couple

with conductors of said second metal layer group regardless of whether said pre-designed circuit

block self-contained layout section conductors are deposed in either a horizontal or vertical

direction; and

wherein said pre-designed circuit block self-contained layout section is a section less than

the entire area of said metal layer in said first metal layer group.

29. (Currently Amended) The method as set forth in claim 28, wherein said pre-

designed circuit block self contained layout section is independent of a layout for said second

metal layer group.

30. (Currently Amended) The method as set forth in claim 28, further comprising a

plurality of pre-designed circuit blocks self contained layout sections in said first metal layer

group.

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31. (Currently Amended) The method as set forth in claim 30, wherein at least one of

said pre-designed circuit blocks self contained layout sections comprise a wiring direction

perpendicular to a wiring direction of a second one of said pre-designed circuit blocks self

contained layout sections.

(Canceled).

33. (Original) The method as set forth in claim 28, wherein said first metal layer

group comprises three metal layers.

34. (Previously Presented) The method as set forth in claim 33, wherein said

three metal layers comprise first, second, and third metal layers, each of said three metal layers

comprising conductors deposed in preferred Manhattan directions, wherein:

said first metal layer comprises a preferred Manhattan direction complementary of a

preferred Manhattan direction of said second metal layer; and

said second metal layer comprises a preferred Manhattan direction complementary of a

preferred Manhattan direction of said third metal layer.

35. (Original) The method as set forth in claim 28, wherein said diagonal direction

comprises a direction 45 degrees relative to said integrated circuit boundaries.

36. (Original) The method as set forth in claim 28, wherein said diagonal direction

comprises a direction 60 degrees relative to said integrated circuit boundaries.

37. (Currently Amended) The method as set forth in claim 28, wherein said pre-

designed circuit block self contained layout section comprises a layout for a memory block.

38. (Canceled).

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39. (Currently Amended) The method as set forth in claim 28, wherein said <u>predesigned circuit block self-contained layout section</u> comprises a section less than 10 percent of the entire area of said metal layer in said first metal layer group.

40-50 (Cancel).

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